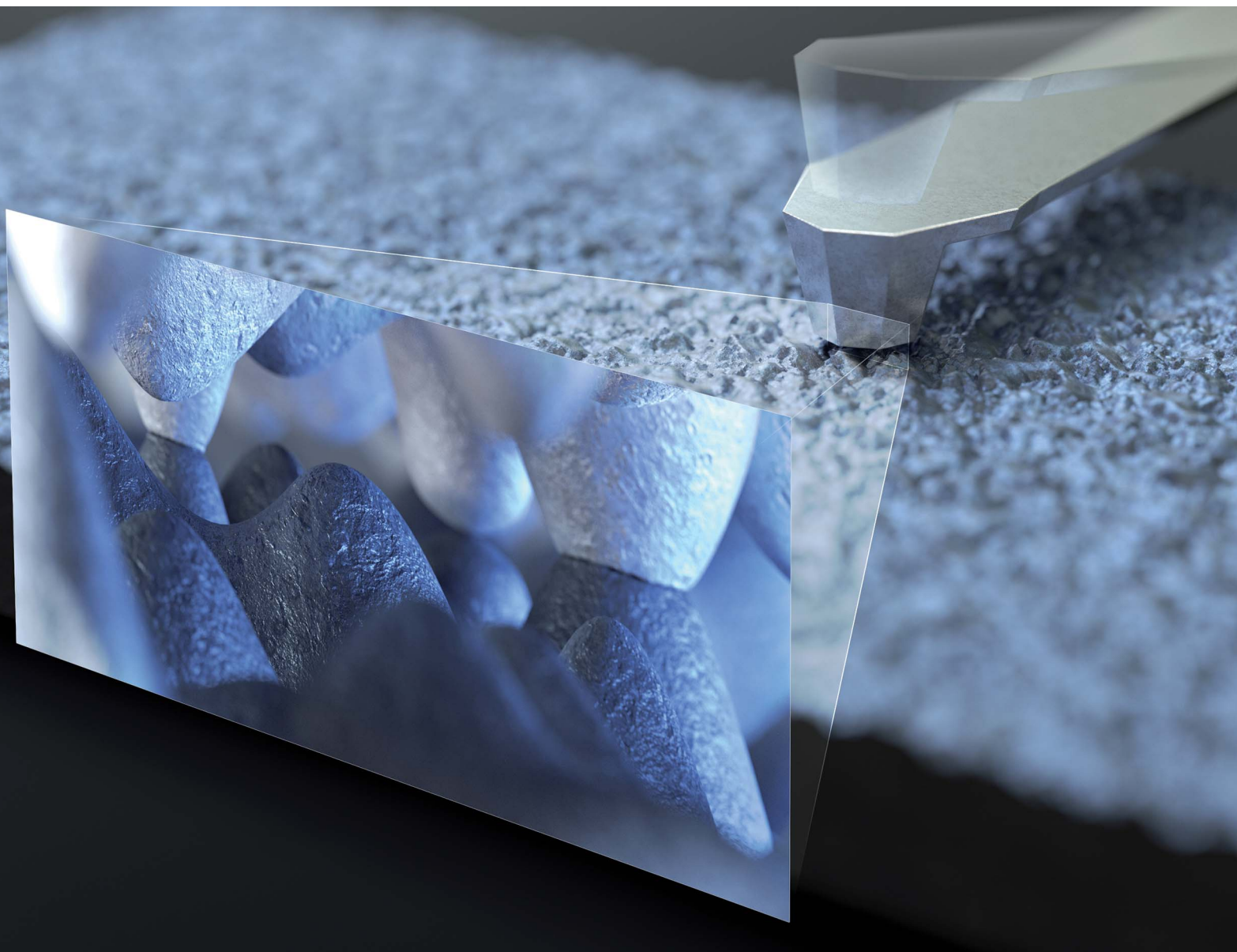


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## An experimental and numerical study on adhesion force at the nanoscale†

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Adhesion has attracted great interest in science and engineering especially in the field pertaining to nanoscience because every form of physical contact is fundamentally a macroscopic observation of interactions between nano-asperities under the adhesion phenomenon. Despite its importance, no practical adhesion prediction model has been developed due to the complexity of examining contact between nano-asperities. Here, we scrutinized the contact phenomenon and developed a contact model, reflecting the physical sequence in which adhesion develops. For the first time ever, our model analyzes the adhesion force and contact properties, such as separation distance, contact location, actual contact area, and the physical deformation of the asperities, between rough surfaces. Through experiments using atomic force microscopy, we demonstrated a low absolute percentage error of 2.8% and 6.55% between the experimental and derived data for Si–Si and Mo–Mo contacts, respectively, and proved the accuracy and practicality of our model in the analysis of the adhesion phenomenon.

### Introduction

Adhesion has been of great research interest for a long time because it is a very fundamental, yet ubiquitous phenomenon observed in our everyday lives beyond our biologically discernible limits in nanotechnology. For instance, adhesion inadvertently exists in various forms in daily lives between contacts as simple as holding and lifting an object to taping a box. The phenomenon is more prominently observed at the nanoscale. Transitioning from the macro to nanoscale, the surface-to-volume ratio becomes significantly higher. As a result, surface forces including adhesion forces gain predominance and become more pronounced.<sup>1–4</sup> Moreover, an extremely close separation distance between asperities on contact interfaces is achieved by the nanometre-scale surface roughness of materials, and the interfacial interaction between surfaces is amplified.

As technological advancements gain tremendous momentum scaling down from the macro to nanoscale in recent years, the role of adhesion force in nanotechnology has become ever more important. Hence, the prediction of adhesion force between solid surfaces is critical not only for practical

use in various fields of nanotechnology, including coatings,<sup>5</sup> transfer printing,<sup>6,7</sup> biomedical,<sup>8</sup> and nanoelectromechanical systems<sup>9–13</sup> but also in the analysis of physical phenomena such as conduction,<sup>14</sup> friction<sup>15</sup> or thermal transport<sup>16</sup> between nano-asperities on material surfaces.

Historically, the importance of adhesion prediction has been acknowledged since Johnson, Kendall, and Roberts (JKR) adopted adhesion force in analysing contact between two spherical bodies in 1971.<sup>17</sup> Afterwards, researchers focused on expanding the scope of the theoretical model from adhesion between a single pair of spheres to surfaces consisting of multi-asperities by applying Hertz,<sup>18</sup> JKR,<sup>17</sup> and Derjaguin–Muller–Toporov (DMT)<sup>19,20</sup> theories. Numerous expanded models analyzed the influence of adhesion force on surface roughness, based on the Greenwood–Williamson model,<sup>21</sup> which first examined contact properties between rough surfaces based on asperities. Fuller and Tabor<sup>22</sup> developed a theory for the contact behavior of adhesive rough surfaces on elastic solids, while Roy Chowdhury and Pollock<sup>23</sup> expanded it to include the influence of plastically deformed asperities. Furthermore, Chang<sup>24</sup> conducted pioneering research on elastic–plastic adhesive contact between rough surfaces. Maugis<sup>25</sup> then extended the DMT theory to elastic contacts of rough surfaces by incorporating the extra load from adhesion around contacts. Morrow<sup>26</sup> provided a solution to make a transition between JKR<sup>17</sup> and DMT<sup>19,20</sup> in the analysis of adhesion in the elastic region. As described, an impressive number of studies have been conducted so far on the adhesion force between rough surfaces consisting of multi-asperities, but most are limited in predicting the accurate value

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of the adhesion force that could be reliably adopted for practical uses such as designing nanoscale devices.

The primary limitation lies in the predominant focus of many researchers on theoretically analyzing adhesion on idealized rough surfaces, with only a few studies incorporating experimental work.<sup>27–30</sup> Additionally, a common approach in most studies involves assuming contact between flat and rough surfaces, modelled based on a large number of asperities with Gaussian height distribution. While this assumption may be effective for simple adhesion analysis, it falls short in accurately predicting adhesion between two rough surfaces in a realistic contact scenario. In contrast to most theoretical works, Prokopovich<sup>27,28</sup> predicted interactions between real rough surfaces by utilizing surface morphology obtained from actual samples being tested and experimentally validated these predictions. However, it is important to note that this study is based on the analysis of contact between flat and rough surfaces within a restricted range of deformation. Consequently, its ability to capture the realistic contact situation is limited.

The second limitation observed in previous studies is insufficient consideration of adhesion forces between non-contacting asperities. Many models<sup>23,25,27,28,30</sup> of rough surface adhesion assume that only areas in direct contact contribute to adhesion, primarily dealing with micrometer-scale roughness. However, in surfaces with nanometer-scale roughness, all non-contacting portions of the interface can be separated by less than 100 nm, and the van der Waals forces that come into play at this distance become non-negligible in the adhesion analysis. DeRiio<sup>31</sup> proposed a model to determine the adhesion force across non-contacting portions of the surfaces based on the calculated equilibrium separation distance between nano-asperities of the contact interface from measured roughness data of two rough surfaces, and experimentally verified the derived adhesion energy using micro-cantilevers. However, this approach disregards adhesion forces between contacting asperities, which could lead to significant errors, particularly in contacts between metals with high surface energy.

Finally, challenges arise when applying the previous models<sup>23–30</sup> in real-life situations where accurate prediction of adhesion force is essential. This becomes particularly critical in the design and functionality of nanoscale devices that demand precise control of motion. The uniqueness of every nanoscale contact interface, stemming from the intricacies of nanoscale fabrication with a multitude of parameters, poses a significant challenge. Disparities between contact surfaces cannot be fully accounted for by previous models developed under fixed conditions. While previous research has successfully studied the very fundamental domains within the adhesion phenomena such as the relationship between surface roughness and the adhesion force, its applicability to real rough contact interfaces remains limited.

To overcome the limitations of existing models and propose a practical prediction model for adhesion, we firstly introduce a new approach to contact analysis in this paper. It stems from the nanoscale observation that the actual contact between interfaces occurs through a series of interactions between nano-asperities on solid surfaces. In the real contact process, nano-

asperities on the contact interface deform sequentially. Because asperities vary in height, the tallest asperity pair on the surfaces contact first. The contacting asperities physically deform with applied external force, and more asperities come into contact. The separation distance between contact interfaces gets smaller until sufficient asperities contact and increased structural rigidity prevents further deformation. In other words, the adhesion force increases until the equilibrium separation distance between contact interfaces is reached. To reflect the dynamics in the natural contact process in our contact model, we calibrated the adhesion force based on the calculated value of the change in interfacial force, separation distance, and deformation of asperities every time a new contact asperity pair is created between interfaces during the contact process.

By employing an iterative and sequential contact analysis process, we present a practical predictive model designed to accurately forecast adhesion forces between contact interfaces across a broad spectrum of materials, including both metals and non-metals. Notably, our model introduces a new iterative contact analysis method by scrutinizing adhesion forces and key contact properties—such as separation distance, contact location, real contact area, and the deformation of contacting asperities—in each step of the contact process. In our approach, we specifically targeted addressing the previously mentioned second limitation, which involves insufficient consideration of adhesion forces between non-contacting asperities. To achieve this, we incorporated an analysis of both the adhesion force among contacting asperities and that of non-contacting ones. Our approach integrates well-established adhesion theories, such as JKR,<sup>17</sup> DMT,<sup>19,20</sup> Kogut & Etsion,<sup>32</sup> and Johnson,<sup>33,34</sup> within the contacting region of asperities, while employing the van der Waals force equation<sup>35</sup> in the non-contacting region of asperities. Lastly, we conducted experimental adhesion measurements using force–distance ( $F$ – $d$ ) measurement utilizing an atomic force microscope (AFM).<sup>36</sup> The result showed a mean absolute percentage error of 2.8% and 6.55% between the experimental and calculated adhesion forces for Si–Si and Mo–Mo contacts, respectively, demonstrating that our model truly reflects the actual contact between material interfaces.

## Results and discussion

### Nanoscale contact model between surfaces

To ensure the proposed nanoscale contact model accurately captures the realistic contact process between rough surfaces, it is essential to incorporate appropriate assumptions. These assumptions serve the purpose of simplifying the intricate process while minimizing the risk of significant errors. In our paper, the following assumptions are adopted:

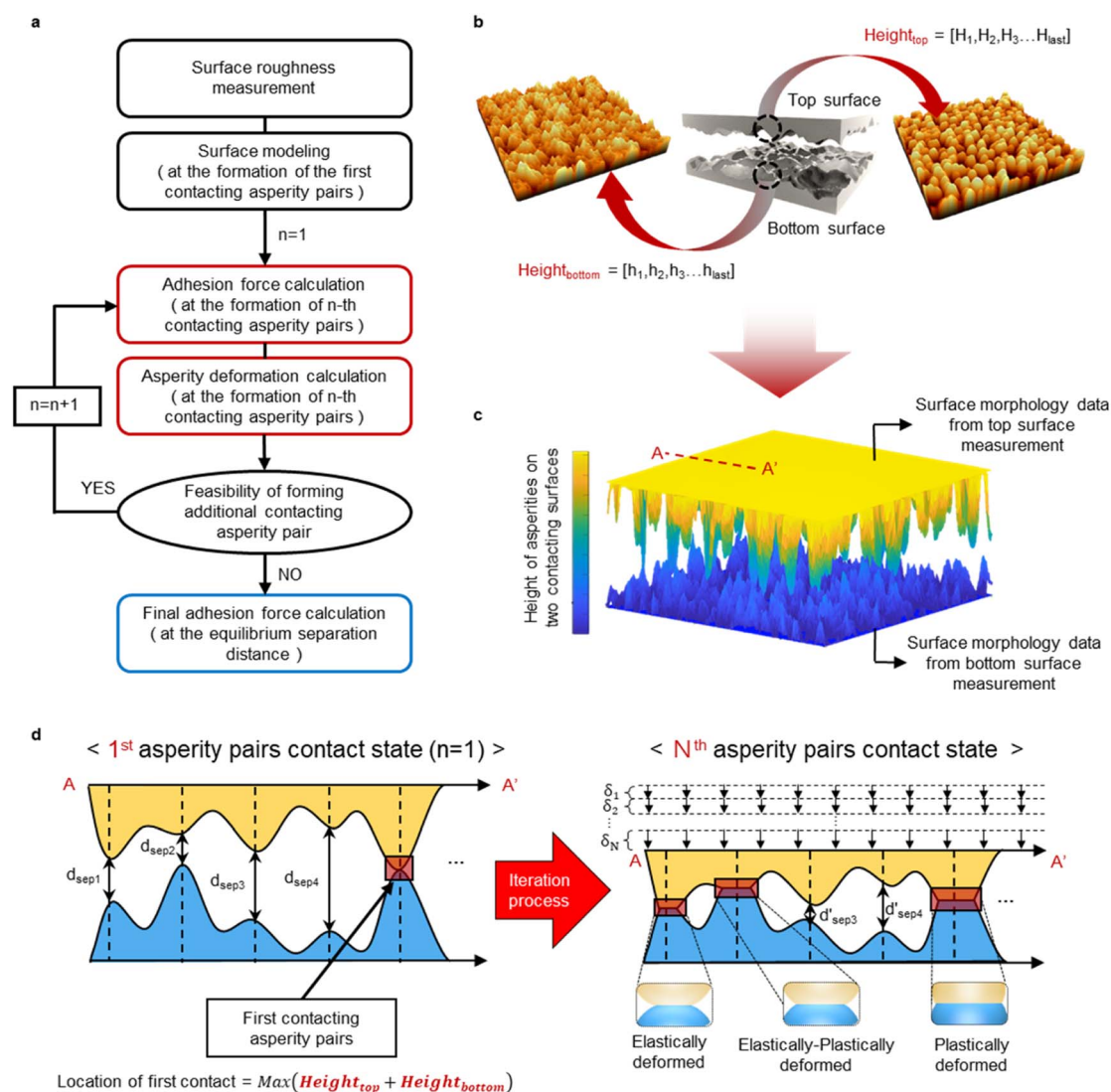
- (a) The rough surfaces exhibit isotropic and homogeneous characteristics.
- (b) The summits of all asperities take on a spherical shape.
- (c) The summits of all asperities share a uniform radius, denoted as  $R$ , while the heights of the asperities vary.
- (d) Deformation of the asperities on surfaces only occur during contact, with no bulk deformation of the mass body.

- (e) Interactions between asperities can be neglected.
- (f) All contact processes are quasi-static.
- (g) The contact surfaces are contamination-free.
- (h) Only dry adhesion is considered.
- (i) The two contacting surfaces are of the same material with identical work functions.
- (j) The two surfaces of contact are not hydrophilic.

The rationale behind the appropriateness of these assumptions, and their reflection of the contact conditions between surfaces, is detailed in ESI S1.†

Fig. 1(a) presents the process flow of the proposed nanoscale contact model. In the first step, surfaces of interest are

analyzed, and the surface model is created based on the obtained data (Fig. S1†) measured using the non-contact mode in AFM (Fig. 1(b)). Because surface morphology is a critical factor in determining the adhesion force, it is important that the nanoscale morphology and non-uniformities of the actual surface of the sample used in the analysis are reflected in collecting the surface roughness data. Fig. 1(c) shows the top and bottom surfaces that are expressed using the measured roughness data, and Fig. 1(d) demonstrates the cross-sectional view of the contact surfaces that we modelled based on the first contacting asperity pair which was obtained by determining the asperity pairs between the top and bottom contact surfaces



**Fig. 1** Proposed nanoscale contact model: (a) flow of the whole process to determine the adhesion force, which mimics the natural iterative contact process. (b) Visual data obtained from measuring the surface roughness using the AFM non-contact mode. (c) Rendered model of the top and bottom surfaces based on the measured roughness data. The color bar ranges from the height of the lowest asperity of the bottom surface to the height of the highest asperity of the top surface. (d) Graphic demonstration showing the cross-sectional image of the 1st and the  $N$ th asperity pairs in the contact state ( $n = 1$ ) and state ( $n = N$ ) after the  $N$ th iteration process in (c), respectively. For the 1st asperity pair that is in the contact state, the separation distances between non-contacting asperity pairs were determined by subtracting the combined height of each non-contacting asperity pair from the total height of the first contacting asperity pair. Greater deformation occurs in the asperity pairs that have reached the contact state earlier, and the type of deformation, whether elastic, elastic-plastic, or plastic, is determined based on the extent of deformation in the overall asperity pairs in the  $n$ -th contact state.

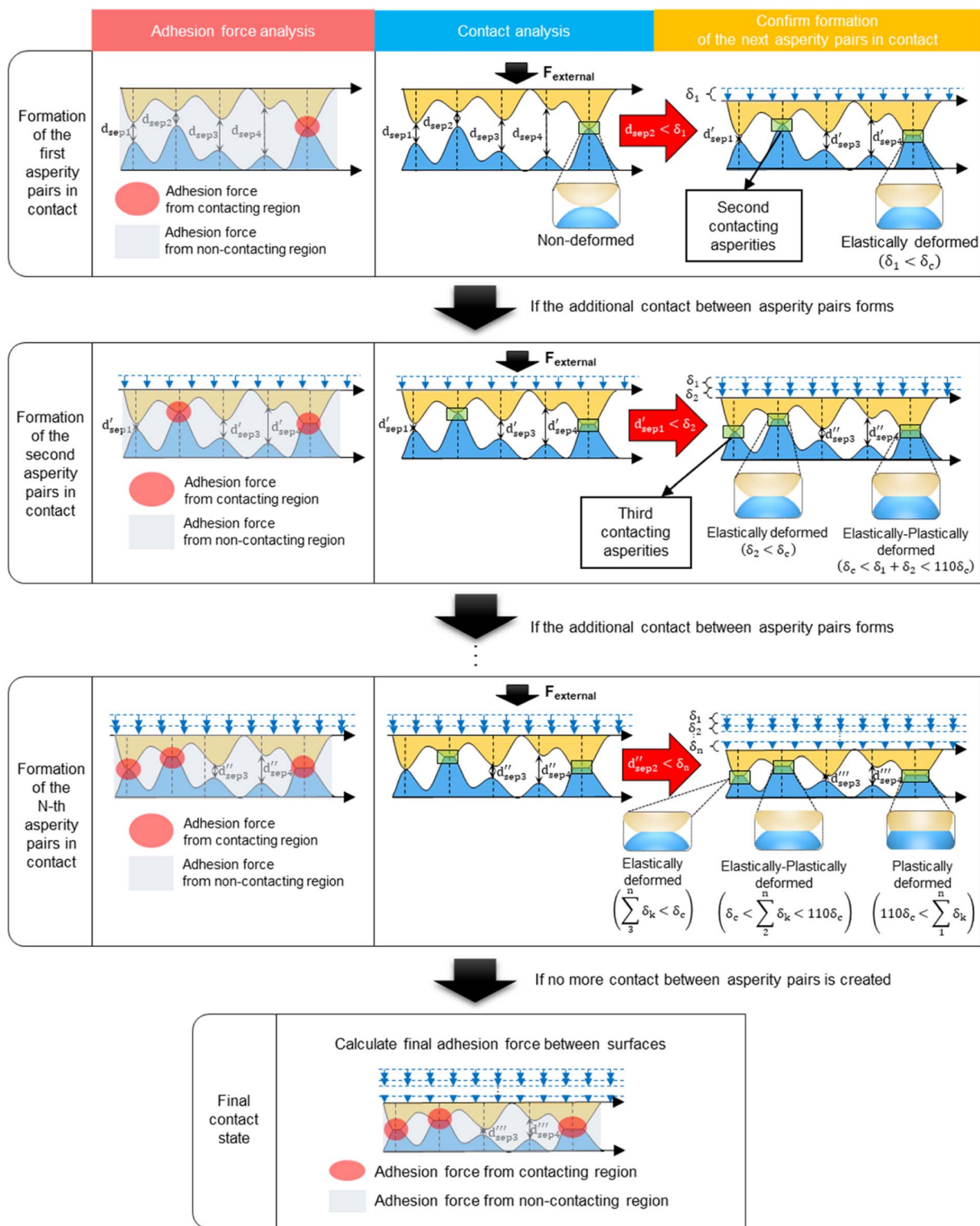


Fig. 2 Iteration process for simulating the real contact process. In the iteration process, the process of adhesion force analysis, contact analysis, and determination of the next separation distance is repeated until the final separation distance is reached. The schematics demonstrate the iterative analytical process of our model from the very first formation of the asperity pairs to the last, when no more new asperity pairs are created due to compressive densification of the contact interface. The aforementioned iterative processes are performed sequentially and repetitively with every new formation of asperity pairs. In the adhesion force analysis, an appropriate adhesion model is determined and utilized based on the contact condition of each of the asperity pairs. In the contact analysis, the extent of deformation between asperity pairs covering both elastic and plastic deformation is analyzed based on the calculated adhesion force from the previous adhesion force analysis and the external force applied between each contact surface. Based on the amount of deformation, our model determines whether additional contact between asperities can be made and more iteration is necessary based on the degree of deformation between existing asperity pairs in contact and the remaining separation distance of the non-contacting asperities.

having the largest combined height. Roughness data obtained by analyzing the top and bottom surfaces from Fig. 1(b) are  $\text{height}_{\text{bottom}} = [h_1, h_2, h_3, \dots, h_{\text{last}}]$  and  $\text{height}_{\text{top}} = [H_1, H_2, H_3, \dots, H_{\text{last}}]$ . From this data, the combined height of the first (initial) contacting asperity pair can be expressed as  $\max(\text{height}_{\text{top}} + \text{height}_{\text{bottom}})$ . Afterward, the separation distance ( $d_{\text{sep}}$ ) between the rest of the non-contacting asperity pairs is determined by

$$d_{\text{sep},n} = \max(\text{height}_{\text{top}} + \text{height}_{\text{bottom}}) - (H_n + h_n) \quad (1)$$

After analysing the adhesion force between the contacting surfaces with the separation distance of the surfaces determined by the initial contact of the asperity pair, the magnitude of deformation experienced by the asperity pair can be calculated. This calculation is based on the compressive force between the surfaces, which is the sum of the external force and the adhesion force. As contacting asperities deform and the two surfaces draw closer, the next taller asperity pair comes into contact. Whenever new asperity pairs make contact, the separation distance between contact interfaces is updated. This updated distance is then utilized to re-calculate both the adhesion force and the extent of deformation between the asperities. The determination of whether additional asperity pairs can form is based on a comparison between the extent of deformation of the contacting asperity pairs and the separation distance between the next taller non-contacting asperity pair. Through this iterative process, illustrated in Fig. 1(d), when the  $N$ th asperity pair makes contact, the contacting asperity pairs attain various contact states, spanning from elastic deformation to plastic deformation. This variation is contingent upon the extent of deformation. At the end, the asperity pairs between the surfaces that remain in non-contact experience a reduction in separation distance compared to their initial contact.

The detailed iteration process, starting from the contact state of the 1st asperity pair to reaching the contact state of the  $N$ th asperity pair, is depicted in Fig. 2. The iteration initiates when the first pair of asperities makes contact and concludes when the asperity pairs cease to deform, and no further contacts occur due to densification. Upon the establishment of contact by a new asperity pair and determination of the corresponding separation distance, a sequential process unfolds, involving adhesion force analysis, contact analysis, and verification of whether the next asperity pairs make contact.

In the analysis of adhesion force, we considered the appropriate interfacial force, considering the material, contact state, and deformation of each asperity pair between contact interfaces. To ensure precision in adhesion force analysis, we performed separate calculations for the adhesion force between contacting asperities and non-contacting asperities.

To determine the adhesion force between contacting asperities, we used the early contact theory of spheres. In the examination of adhesion forces between contacting asperity pairs situated in the elastic region, either the JKR<sup>17</sup> or DMT<sup>19,20</sup> theory is employed depending on the material properties. The JKR theory is typically applicable to soft materials like rubber, while

the DMT theory is suitable for hard materials such as metal. The determination of the appropriate theory for the material under analysis is facilitated by employing a Tabor parameter<sup>37</sup> as follows:

$$\mu = \sqrt[3]{\frac{RW^2}{E^* \epsilon^3}} \quad (2)$$

$$\frac{1}{E^*} = \frac{1 - \nu_1^2}{E_1} + \frac{1 - \nu_2^2}{E_2}$$

where  $\mu$  is the Tabor parameter,  $R$  is the radius of curvature,  $W$  is the work of adhesion,  $\epsilon$  is the intermolecular distance,  $E$  is the effective Young's modulus, and  $\nu$  is Poisson's ratio. The DMT theory is used in the analysis when the tabor parameter is low ( $<1$ ). In contrast, the JKR theory is applied when the Tabor parameter is significantly high ( $\gg 1$ ). Eqn (3)–(5) below detail the formulas for determining the contact radius, deformation of nano-asperities, and adhesion force, employing the JKR theory.

$$a_{\text{JKR}}^3 = \frac{R}{K} \left( F_0 + 3\pi W \bar{R} + \sqrt{6\pi W \bar{R} F_0 + (3\pi W \bar{R})^2} \right) \quad (3)$$

$$\delta_{\text{JKR}} = \frac{a^2}{R} - \sqrt{\frac{8\pi a W}{3K}} \quad (4)$$

$$F_{\text{adh\_JKR}} = \frac{3}{2} \pi \bar{R} W \quad (5)$$

Likewise, eqn (6)–(8) outline the calculations for the contact radius, deformation of nano-asperities, and adhesion force using the DMT theory.

$$a_{\text{DMT}}^3 = \frac{R}{K} (F_0 + 2\pi W \bar{R}) \quad (6)$$

$$\delta_{\text{DMT}} = \frac{a^2}{R} \quad (7)$$

$$F_{\text{adh\_DMT}} = 2\pi \bar{R} W \quad (8)$$

$$K = \frac{4}{3} \left( \frac{1 - \nu_1^2}{E_1} + \frac{1 - \nu_2^2}{E_2} \right)^{-1}$$

$$\bar{R} = \frac{R_1 R_2}{R_1 + R_2}$$

where  $a$  is the contact radius,  $\delta$  is the deformation of asperities,  $F_{\text{adh}}$  is the adhesion force,  $R$  is the radius of curvature,  $W$  is the work of adhesion,  $F_0$  is the applied pressure,  $E$  is the effective Young's modulus, and  $\nu$  is Poisson's ratio.

The contacting asperities in the elastic–plastic deformation region are calculated by Kagot and Etsion's model,<sup>32</sup> which are analyzed using finite element analysis and numerical fitting. The formulas are categorized into two ranges based on the

degree of deformation ( $\delta$ ) and further subdivided into two additional ranges according to the magnitude of critical deformation ( $\delta_c$ ). Finally, four derived formulas in eqn (9)–(12) can be used to calculate the deformation of asperities and adhesion force in the intermediate regions of elasticity and plasticity. The four equations are described below:

When  $0.005 < \frac{\varepsilon}{\delta_c} < 0.5$ ,

$$\frac{F_{adh}}{F_{adh0}} = 0.792 \left(\frac{\varepsilon}{\delta_c}\right)^{-0.321} \left(\frac{\delta}{\delta_c}\right)^{0.356} \quad \text{for } 1 < \frac{\delta}{\delta_c} < 6 \quad (9)$$

$$\frac{F_{adh}}{F_{adh0}} = 1.193 \left(\frac{\varepsilon}{\delta_c}\right)^{-0.332} \left(\frac{\delta}{\delta_c}\right)^{0.093} \quad \text{for } 6 < \frac{\delta}{\delta_c} < 110 \quad (10)$$

When  $0.5 < \frac{\varepsilon}{\delta_c} < 100$ ,

$$\frac{F_{adh}}{F_{adh0}} = 0.961 + \frac{0.157}{\frac{\varepsilon}{\delta_c}} + \frac{0.261 \ln\left(\frac{\delta}{\delta_c}\right)}{\frac{\varepsilon}{\delta_c}} \quad \text{for } 1 < \frac{\delta}{\delta_c} < 6 \quad (11)$$

$$\begin{aligned} \frac{F_{adh}}{F_{adh0}} = & 1.756 - \left(0.516 - \frac{0.303}{\frac{\varepsilon}{\delta_c}}\right) \ln\left(\frac{\delta}{\delta_c}\right) \\ & + 0.052 \left(\ln\frac{\delta}{\delta_c}\right)^2 \quad \text{for } 1 < \frac{\delta}{\delta_c} < 6 \quad (12) \end{aligned}$$

where  $\delta$  is the deformation of asperities,  $\delta_c$  is the critical deformation of asperities,  $\varepsilon$  is the intermolecular distance,  $F_{adh}$  is the adhesion force, and  $F_{adh0}$  is the adhesion force at the point of contact.

In the plastic deformation region, Johnson's theory<sup>33,34</sup> is used, which delineates adhesion forces between small particles or asperities as relevant to both loading and unloading processes. These processes entail the application and removal of an external force on two contacting surfaces. During the loading process, hardness factors in as a key parameter to determine the contact radius, and the contact radius and deformation of asperities can be obtained as shown in eqn (13) and (14). In the unloading process, however, the behaviors of the spheres or asperities are more complex as their separation behaviors are either brittle or ductile depending on the contact radius at maximum compression, hardness, work of adhesion, and effective Young's modulus of the contacting body of mass. The brittle separation is marked by the elastic separation of spheres or asperities in contact, with the adhesion force during this process calculable using eqn (15). In contrast, ductile separation is characterized by inelastic separation of spheres, and the resulting adhesion force can be determined using eqn (16).

$$H\pi a^2 = 2\pi RW + F_0 \quad (13)$$

$$\delta_{\text{Johnson}} = \frac{a^2}{2R} \quad (14)$$

$$F_{adh, brittle} = -\frac{2WE^*a}{H} \quad (15)$$

$$F_{adh, ductile} = H\pi a^2 \quad (16)$$

where  $H$  is hardness,  $a$  is the contact radius,  $\delta$  is the deformation of asperities,  $F_{adh}$  is the adhesion force,  $R$  is the radius of curvature,  $W$  is the work of adhesion,  $F_0$  is the applied pressure,  $E$  is the effective Young's modulus, and  $\nu$  is Poisson's ratio.

In contrast to analyzing the adhesion force between contacting asperities, the analysis of the non-contacting region between the two surfaces primarily focuses on attractive forces that manifest over long distances. While various forces may exist between surfaces with significant separation distances, our paper predominantly concentrates on the van der Waals force. This force, omnipresent between all substances, operates within the interatomic spacing range of approximately 0.2 nm to 10 nm and beyond.<sup>35</sup> The exclusive consideration of the van der Waals force is attributed to our primary focus on the contact between identical substances under dry conditions. The van der Waals force can be obtained with eqn (17) below.

$$F_{adh, vdW}(d_{sep}) = \frac{A}{6\pi d_{sep}^3} g_c(d_{sep}) \times \text{area} \quad (17)$$

$$\begin{aligned} g_c(d_{sep}) = & 1 - \frac{2(d_{sep})}{c} + \frac{6(d_{sep}^2)}{c^2} + \frac{12(d_{sep}^3)}{c^3} \\ & - \frac{12(d_{sep}^3)}{c^4} (d_{sep} + c) \ln\left(1 + \frac{c}{d_{sep}}\right) \end{aligned}$$

where  $A$  is the Hamaker constant,  $d_{sep}$  is the separation distance between asperities, and  $c$  is a characteristic wavelength constant. As shown in the equation, the van der Waals force is influenced by separation distance and contact area and is inversely proportional to the third power of distance.

The comprehensive adhesion force between surfaces is derived by independently calculating the adhesion force in both the contacting and non-contacting regions of the surface. Summing up each individual calculation allows for a precise analysis of the adhesion force. More specifically, the adhesion force for each contacting asperity pair is computed based on its deformation state and subsequently aggregated. In the non-contacting region, the adhesion force is computed with a primary emphasis on the overlapping area characterized by a specific separation distance. Accordingly, the total adhesion force between the rough surfaces is calculated as follows:

$$F_{a_t} = \sum_1^i F_{a_E} + \sum_1^j F_{a_{EP}} + \sum_1^k F_{a_P} + F_{\text{van der Waals}} \quad (18)$$

where  $F_{a_t}$  is the total adhesion force,  $F_{a_E}$  is the adhesion force between asperity pairs in elastic deformation,  $F_{a_P}$  is the adhesion force between asperity pairs in plastic deformation, and  $F_{\text{van der Waals}}$  is the van der Waals force in the non-contacting region.

By accounting for the adhesion force between contacting and non-contacting asperities, the accuracy of the adhesion force

analysis is substantially enhanced. During the analysis of adhesion force, the dominance of either the adhesion force in the contacting region or non-contacting asperities depends on the material in question. For instance, in metallic contacts with high surface energy,<sup>35,38</sup> the prevailing force between contacting asperities is metallic bonding, which surpasses van der Waals forces. Therefore, the interfacial force between contacting asperities is given particular emphasis in metallic contact, where metallic bonding force prevails over van der Waals force. Conversely, in non-metallic contact, where van der Waals force dominates between interfaces, the attractive force between non-contacting asperities is accentuated.<sup>31,35</sup> For these reasons, it is essential to analyze both contacting and non-contacting asperities to develop a model with a wide range of applicability to various types of materials. Our model comprehensively considers different types of contacts, thereby facilitating a precise and comprehensive analysis of various conditions in interfacial contacts.

In our contact analysis, the deformation of asperities is determined considering material properties and the sum of adhesion force and external force. The deformation regions are classified into three areas: elastic, elastic-plastic, and plastic. The criterion for delineating these ranges is established by the critical deformation value defined in eqn (19).<sup>39</sup>

$$\delta_c = \left( \frac{\pi CH}{2E^*} \right)^2 R \quad (19)$$

$$C = 0.454 + 0.41\nu$$

where  $\delta_c$  is critical deformation,  $H$  is the hardness of the material,  $R$  is the radius of curvature, and  $\nu$  is Poisson's ratio. If the extent of deformation is below the critical deformation, it is deemed to fall within the elastic region. Plastic deformation initiates once the magnitude of deformation surpasses the critical deformation, yet remains outside the realm of complete plasticity at the intermediate elastic-plastic region where both elastic and plastic deformations occur. When the deformation exceeds the critical threshold by a factor of 110, the asperity transitions into the fully plastic zone.

The deformation of nano-asperities plays a critical role in determining the separation distance and adhesion force between two contacting rough surfaces. Therefore, when analyzing adhesion between two rough surfaces, the deformation of asperities must be considered in context. The deformation of asperities is calculated using the aforementioned early contact theories between spheres according to the deformation range.

After completion of the adhesion force and the contact analysis for the first contacting asperity pair, the possibility of the following contact is analyzed based on the magnitude of deformation in the preceding contact pairs. If the deformation in the first asperity pair in contact is sufficient to cover the separation distance between the asperities that are on the brink of contact, the next contact is established. As more asperities come into contact, the magnitude of deformation in the

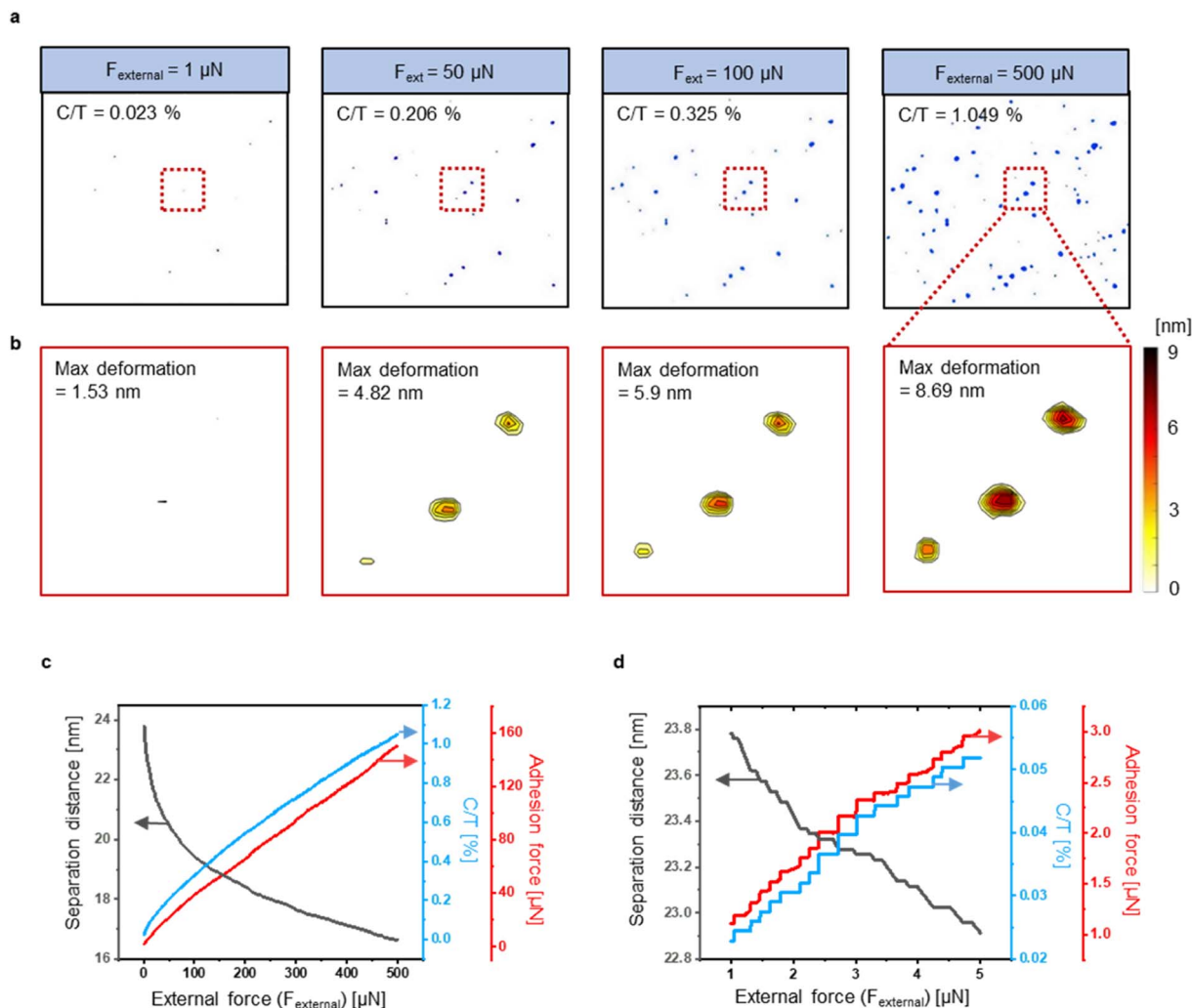
asperities subsides due to the increased repulsive force between contacting asperities and the incremented structural rigidity from densification of the contact pairs. Accordingly, the iterative analysis stops at the  $n$ -th pair of the asperities where the value of the separation distance required for the next asperity contact ( $(n + 1)$ -th) is greater than the value of the mechanical deformation of the existing asperity pairs in contact. At this point, the final separation distance can be calculated and the resulting adhesion force is determined by utilizing the separation distance and the contact and deformation states of the asperities in the final state.

### Analysis of nanoscale contact properties between surfaces

To deeply understand the contact on the nanoscale, we analyzed adhesion force and various contact properties such as location, contact area, and deformation of contacting asperities. Using the proposed model, it is possible to examine contact phenomena that occur in every step of the iteration process. Fig. 3 visualizes the contact properties between two surfaces upon applying an external force. Fig. 3(a) shows that the proposed model can extract contact locations and real contact areas according to applied external forces ranging from 1 to 500  $\mu\text{N}$ . The ratio of real contact area to the total apparent area ( $C/T$ ) is found to be only 1.049% at the relatively high external force of 500  $\mu\text{N}$ . The degree of deformation of the contacting asperities is demonstrated in Fig. 3(b). As the iteration process progresses, the deformation of the first contacting asperities increases, and new contact points are generated. Hence, the deformation of individual asperity pairs can be clearly analyzed using the proposed model. This contact process between interfaces that prolongs until the equilibrium separation distance is reached is visually demonstrated in Video S1.†

As shown in Fig. 3(c) and (d), the resultant separation distance,  $C/T$ , and adhesion force from the applied external force can be obtained through the iterative process using the model. Here, Fig. 3(c) demonstrates the direct relationship between the contact properties and the external forces and Fig. 3(d) shows the magnified image of Fig. 3(c). Demonstrating the resultant adhesion force from the microscopic applied forces, Fig. 3(c) exhibits a smooth linear curve. On the other hand, in Fig. 3(d), a step-wise change in the adhesion force between interfaces was shown when forces in the nanoscale were applied. Here, the abrupt increment in the adhesion force is due to the additional attractive force that occurs when contact between nano-asperities is newly formed. This trend in the adhesion forces is highly comparable to the experimental findings of the previous behavioral studies in nano-contacts in which quantized movement in physical phenomena such as friction, conduction, and thermal transport due to atomistic accounting<sup>14–16,40–42</sup> was observed, suggesting that our proposed model can also be a powerful tool for studying non-continuum nano-contact behavior analysis. Moreover, our model can further extend its applicability to accurate analysis of nano-phenomena at the atomic level if atomic-scale surface morphology can be measured.<sup>43,44</sup>





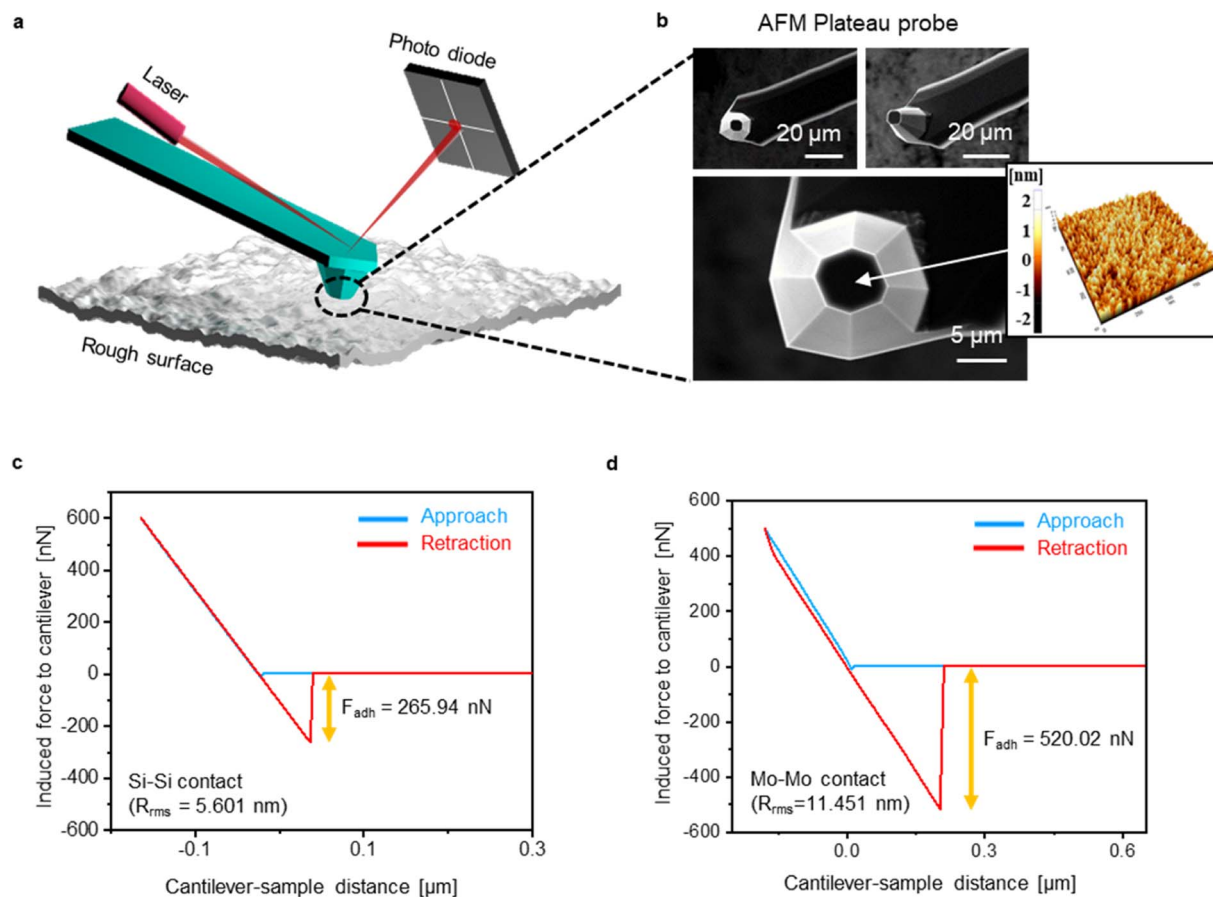
**Fig. 3** Analyzed contact phenomenon and properties using the proposed contact model. The proposed model can analyze the location, real contact area, and deformation of the contacting asperities in each step of the iteration process as shown in the visualization. The overall area of the contact between surfaces is  $2 \mu\text{m} \times 2 \mu\text{m}$  and the surface material is molybdenum. The RMS roughness are 10.46 nm and 5.07 nm for the sample and the AFM tip, respectively. (a) Graphics, from left to right, showing the location of the contact and the actual contact area between surfaces under the applied external force of 1  $\mu\text{N}$ , 50  $\mu\text{N}$ , 100  $\mu\text{N}$ , and 500  $\mu\text{N}$ . Each state can also be viewed as an intermediate process visualizing the mechanical changes in the real contacts as forces are applied incrementally up to 500  $\mu\text{N}$ . This contact process between interfaces is visually demonstrated in Video S1.† (b) A magnified image showing the degree of deformation of the contacting asperities when the external forces of 1  $\mu\text{N}$ , 50  $\mu\text{N}$ , 100  $\mu\text{N}$ , and 500  $\mu\text{N}$  are applied. The color bar shows the deformation value at each point, and the max deformation value increases as a large force is applied. (c and d) Graph of separation distance (black; left axis), C/T (blue; right axis), and the adhesion force (red; right axis) according to the applied external forces. (c) Is a graph obtained by extracting data in units of 1  $\mu\text{N}$  when the external force applied to the surface ranged from 1  $\mu\text{N}$  to 500  $\mu\text{N}$ , and (d) is a portion of the graph from Fig. 2(c) with a magnification factor of 100, obtained by extracting data in units of 10 nN when the external force applied to the surface is 1  $\mu\text{N}$  to 5  $\mu\text{N}$ .

Overall, Fig. 3(c) and (d) demonstrate that each contact between asperities, consisting of only a minute proportion of the entire surface, critically affects the total adhesion force between contacting interfaces when the applied compressive forces are in the range of nano-newton scale. The van der Waals force generally increases as the separation distance between surfaces decreases. However, in case of molybdenum, the metallic bonding forces between contacting asperities are much larger than the van der Waals force. Hence, as individual asperities come into contact with increasing external force at the nanoscale, adhesion force, dominated by metallic bonding force, increases in direct relation to the number of contacting

asperities, forming a step-wise trend. The proposed model, therefore, can analyze in detail the adhesion force and contact properties between user-defined surfaces in the unit of desired forces.

#### Verification of the proposed model with AFM experiments

We conducted an AFM  $F-d$  experiment and implemented the proposed model for experimental verification. Fig. 4(a) shows an experimental setup of the  $F-d$  measurement in AFM. What is special in this experiment is that we introduced the plateau probe to our experiments for experimental measurement of



**Fig. 4** AFM experiment utilizing the special plateau probe. (a) Schematic illustration of the setup for AFM  $F-d$  measurements and (b) SEM images of the AFM plateau probe. AFM  $F-d$  measurement is a simple and reliable way to quantitatively explore the adhesion force between the sample and the tip. For surface to surface contact, the plateau probes having defined contact areas were used in the experiment. For surface to surface contact, the plateau probe with the contact area is used in the experiment. (c) Measured AFM  $F-d$  curves of Si-Si contact when the external force of 600 nN is applied to the Si sample having RMS roughness of 5.601 nm. (d) Measured AFM  $F-d$  curves of Mo-Mo contact when the external force of 500 nN was applied to the Mo sample having RMS roughness of 11.451 nm. Tip-sample interactions are demonstrated in the graph (blue solid line: tip approach, red solid line: tip retraction).

adhesion force in surface-to-surface contact (Fig. 4(b)). Unlike the general AFM probe, the tip of the probe is plateaued out, allowing the measurement of the adhesion force between designated areas of contacting interfaces. The experimental value of the adhesion force was obtained from the resulting graph based on the  $F-d$  measurement conducted using the special AFM tips and the prepared samples with defined roughness spec. The measured adhesion force was obtained in the retraction process of the  $F-d$  measurement (Fig. S2†).

Prior to the experiment, roughness of the sample and the AFM probe was measured (Fig. S3 and S4†). Following the experimental measurement, we compared the values of the adhesion forces obtained through the experiments and those predicted through the proposed contact model. We experimented using a non-metallic material of silicon (Si) and metallic material of molybdenum (Mo), which are widely used in CMOS and M/NEMS industries. Fig. 4(c) and (d) show the  $F-d$  curves obtained between an Si sample and Si probe, and Mo sample and Mo-coated probe, respectively. The interaction between the AFM probe and sample is demonstrated in the

graph, and the experimental data was obtained from the retraction curve of the adhesion force. The experimental results of Si-Si and Mo-Mo contacts are shown and compared in the graphs in Fig. 5 and 6, respectively. Applied pressure and RMS roughness were compared to both the final separation distance and the adhesion force in Fig. 5(a) and (b), respectively, and demonstrated that a smaller final separation distance results in a larger adhesion force. Furthermore, the adhesion forces found based on the calculated final separation distances using our model were similar to those obtained from our experiment. Also, the graphs demonstrate that the change in the final separation distance according to surface roughness significantly impacts the final adhesion force. Moving forward, the Mo-Mo contact in Fig. 6(a) and (b) shows similar results to the Si-Si contact. However, it shows that a relatively small change in the separation distance results in a significant difference in the adhesion force due to the large metallic bonding force at the contacting region of the asperities. The graphs in Fig. 5(c) and 6(c) show a quantitative comparison and error analysis between the adhesion forces calculated using our model and those from

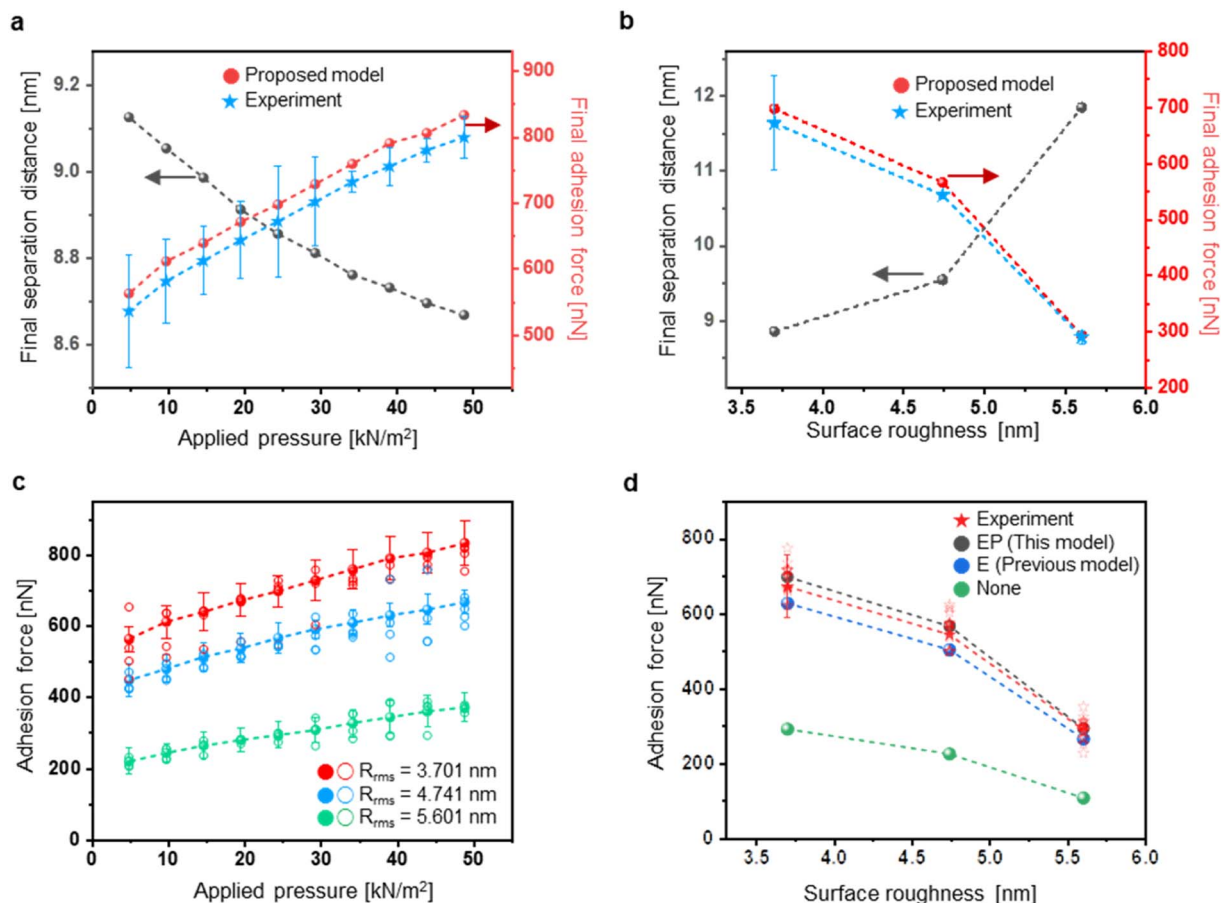
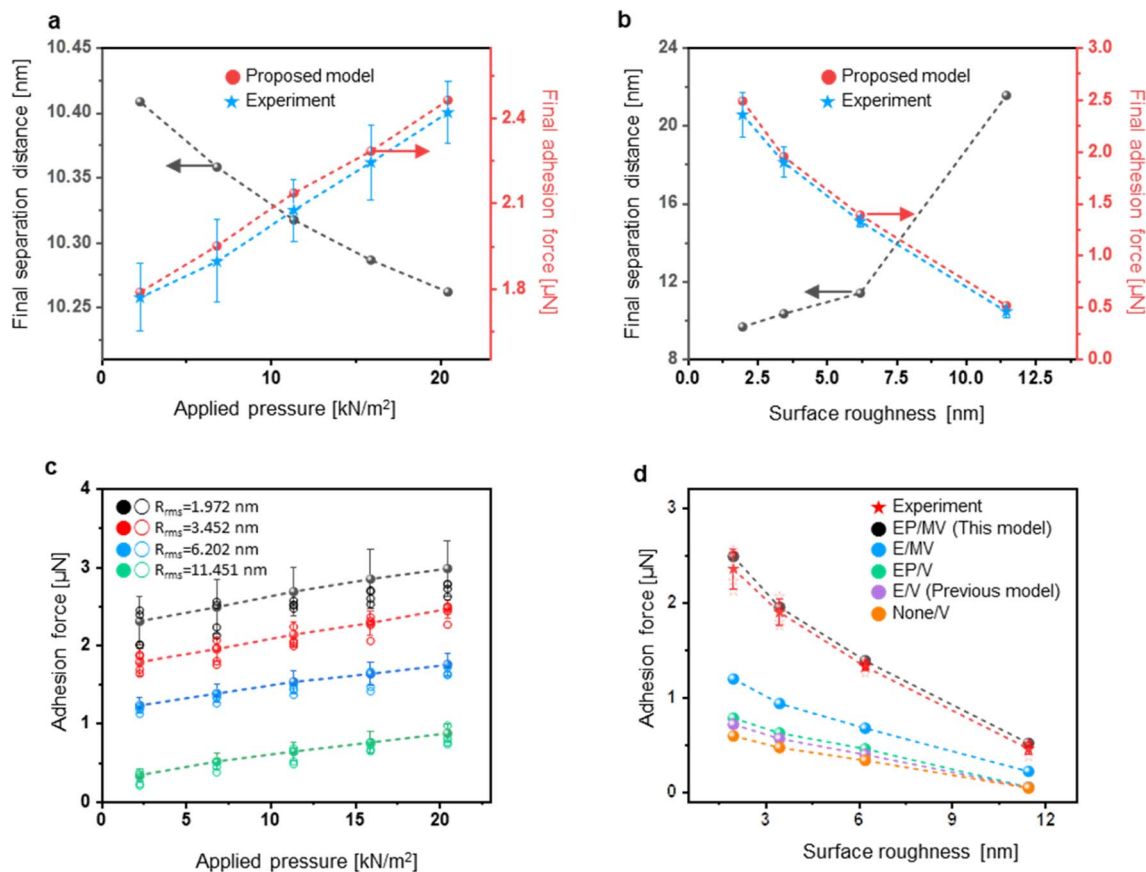


Fig. 5 Experimental verification in Si-Si contact (non-metallic contact): (a) graph of the final separation distance (left axis) and final adhesion force (right axis) versus applied pressure when the surface RMS roughness of the sample is 3.701 nm. (b) Graph of the final separation distance (left axis) and final adhesion force (right axis) versus surface RMS roughness when the applied pressure is  $24.39 \text{ kN m}^{-2}$ . The red circles on the right axis present the predictive value of adhesion force by using the proposed model. And the blue stars in the right axis present the experimental value of adhesion force obtained from the AFM  $F-d$  experiment. (c) Quantitative comparison between modeling and experimental values of adhesion force according to contact force at the surface with RMS roughness of 3.701 nm, 4.741 nm, and 5.601 nm. (d) Comparison between experimental and predicted values with different consideration conditions of contact model at an external force of  $1000 \mu\text{N}$ . The factors of consideration are the deformation region (E: elastic deformation, P: plastic deformation). The red star is the experimental value (filled: average value; open: individual value). The black circle is the computed value using the proposed model in this research considering both elastic and plastic deformation, the blue circle is the computed value considering only elastic deformation, and the green circle is the computed value of the adhesion force in the first asperity contact situation without any deformation of asperities.

the experiment under various applied pressures and surface roughness. The disparity between the predicted and experimentally obtained adhesion forces is quantified using the absolute percentage error. The absolute percentage error is a measure of the absolute difference between the predicted and actual values, expressed as a percentage. Accordingly, an average of 2.8% and a maximum of 5.41% in absolute percentage error of the Si-Si contact were observed. Also, an average of 6.55% and a maximum of 12.4% were found to be the absolute percentage error of the Mo-Mo contact. The results demonstrate that the proposed contact model is highly accurate as opposed to the previously reported contact models having error rates of at least 25%. Moreover, we found that the smaller the roughness value, the larger the applied pressure and the greater the adhesion force. Next, Fig. 5(d) and 6(d) compare the predicted values with the experimental values based on the material types and deformation region. In the case of the Si-Si

contact, deformation of the asperities highly affects the magnitude of the adhesion force, but the effect of deformation regions, whether elastic or elastic-plastic, on the adhesion force is trivial because silicon has very small surface energy. Within the range of the applied pressure, elastic deformation predominantly occurs, so plastic deformation has no significant influence over the adhesion force. However, unlike Si-Si contacts, Mo-Mo contacts induce a considerable degree of plastic deformation due to the high surface energy of the metal. The values shown in the green and purple circles differed significantly from the experimental values because plastic deformation was not considered. Additionally, Fig. 6(d) shows that metallic bonding force comprises a significant portion of the overall adhesion force between surfaces. The green, purple, and orange circles were calculated based on van der Waals force without considering the metallic bonding force in the contacting region, and displayed significant errors against the



**Fig. 6** Experimental verification of Mo–Mo contact (metallic contact): (a) graph of the final separation distance (left axis) and the final adhesion force (right axis) versus applied pressure for the sample having a surface RMS roughness of 3.452 nm. (b) Graph of the final separation distance (left axis) and the final adhesion force versus surface RMS roughness under the applied pressure of 6.81  $\text{kN m}^{-2}$ . The red circles on the right axis present the predicted values of the adhesion forces obtained utilizing the proposed model, and the blue stars in the right axis present the experimental value of the adhesion forces obtained from the AFM  $F$ – $d$  experiment. (c) Quantitative comparison between the predicted (filled) and experimental (open) values of the adhesion forces according to various contact forces applied to the surface having RMS roughness of 1.972 nm, 3.452 nm, 6.202 nm, and 11.451 nm. (d) Comparison between the experimental and predicted values of the adhesion forces at the applied external force of 300  $\mu\text{N}$  when different models were used. Different combinations of deformation regions (E: elastic deformation, P: plastic deformation) and intermolecular forces (V: van der Waals force, M: metallic bonding force) were considered for each model. The red stars represent the experimental values. The black circles are the computed values obtained from the proposed contact model by considering both elastic and plastic deformations, and both metallic bonding and van der Waals forces. The blue circles are also computed values using the proposed model when only elastic deformation was considered along with the metallic bonding and van der Waals forces. Lastly, the green, purple, and orange represent the computed values, in which metallic bonding forces were not considered as part of the calculations. However, all deformation regions were considered for the data represented in the green circles while only the elastic deformation region accounted for those shown in purple. Lastly, the data shown in orange represents the computed adhesion forces when mechanical deformation of the asperities was factored out.

experimental values. These results demonstrate the importance of considering appropriate adhesion forces and deformation ranges to develop an accurate adhesion force prediction model that could be practically utilized in various contact situations.

Overall, our proposed model displayed significantly improved accuracy compared to the previous models. Beyond its capability to accurately analyze adhesion force in nanoscale contacts, our model can become a foundation for analyzing various nano-physical phenomena such as electrical resistance, friction, or thermal transport. As an example, we demonstrated in ESI S5† the analysis of the contact process between two material interfaces and calculation of electrical resistance in parallel between nano-asperity pairs using our proposed model.

Moreover, we compared the electrical contact resistance of our fabricated NEMS device between the calculated value using our model and the measured data from electrical testing (Fig. S6 and S7†). Hence, we demonstrated that our model successfully overcame previous limitations in calculating electrical contact resistance between nano-asperities due to the difficulties in analyzing the nanoscale contact phenomenon.

## Conclusions

In our study, we introduce a practical nanoscale adhesion model capable of simulating both non-metallic and metallic contacts, taking into account the realistic contact process. This

model employs an iterative analysis of contact and adhesion forces through a feedback loop, considering dynamic changes in the separation distance between surfaces. Through the sequential contact process of nano-asperities on contact interfaces, our model achieves a low absolute percentage error between experimental and predicted values. This suggests that our model serves as a valuable tool in unravelling the long-standing ambiguity surrounding the contact phenomenon. Furthermore, our analytical results on nanoscale contact properties using this model are comparable to the experimental verification of the quantized movement of physical phenomena such as friction, conduction, and thermal transport due to atomistic accounting on the nanoscale, which further confirms the model's accuracy. While certain assumptions were made to develop a practical predictive adhesion model, including the exclusive analysis of dry adhesion forces to simplify attractive forces between adjacent surfaces, our model exhibits limitations in analyzing adhesion forces under specific conditions, such as environments with high humidity or hydrophilic surfaces. Furthermore, our model is limited in analyzing materials with intermediate properties not covered by JKR and DMT theories. Despite these limitations, we believe our model establishes a practical and predictive tool that can be utilized with high accuracy for predicting the contact of materials across diverse surface energy ranges, spanning from metal to non-metal. Through the iterative analysis of the contact process, simulating a realistic contact scenario, we envision the potential for a comprehensive examination of various interfacial forces that come into play between surfaces. Furthermore, expanding experimental verifications of adhesion forces beyond our current tests involving Si and Mo surfaces to include other nano devices would contribute to the continual refinement of our model. As such, our model serves as a foundational tool for the analysis of adhesion forces across a diverse range of applications and the exploration of various physical phenomena at the nanoscale.

## Experimental

### Surface roughness measurement

The surface roughness measurement was performed in the non-contact mode of the AFM system (Park, XE-100) with an AFM tip (NCHR, resonant frequency: 320 kHz, force constant: 42 N m<sup>-1</sup>). The scan size was 2 × 2 μm<sup>2</sup> with 256 pixels, and data was measured through the line-fit of flattening routines and Z-drive mode.

### AFM *F*-*d* experiment

Adhesion force measurements were performed by the AFM system (Park, NX-10) in the ambient air conditions (at the measurement environment temperature of 19 °C and humidity of 18%). For the surface-to-surface contact examination, a special AFM tip (PL-FMR, resonant frequency: 75 kHz, force constant: 2.8 N m<sup>-1</sup>) was used. To analyze the adhesion forces for Mo–Mo contact, the silicon tip was coated with 40 nm of molybdenum. Before the experiment, sensitivity calibration for

obtaining the correct *F*-*d* curve was performed in the AFM program (SmartScan RTM12d). Vertical contact and separation processes were executed using a piezo-electrically moved tip-mounted stage of the AFM (0.3 μm s<sup>-1</sup>). The AFM tips were used to measure each of the 4 silicon and molybdenum samples, and each tip was used 16 times.

## Author contributions

Conceptualization: S.-H. K., P.-K. C., Y.-B. L.; data analysis: S.-H. K., Y.-B. L.; methodology: S.-H. K., P.-K. C., Y.-B. L.; resources: T.-S. K., S.-Y. L.; supervision: J.-B. Y.; visualization: S.-H. K., P.-K. C.; writing – original draft: S.-H. K.; writing – review and editing: S.-H. K., P.-K. C., Y.-B. L., M.-S. J., H.-W. M., J.-B. Y.

## Conflicts of interest

The authors declare that they have no competing interests.

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